

Report APR-21-H0757-A  
Date: 28/Feb./2023

# RENESAS SEMICONDUCTOR RELIABILITY REPORT

SERIES: PS9821-2

DEVICE: PS9821-2-AX  
PS9821-2-F3-AX  
PS9821-2-V-AX  
PS9821-2-V-F3-AX

APPLICATION: Standard

Quality Assurance Division  
Renesas Electronics Corporation

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## Reliability test result

| Test Items                                    | Reference              | Test Conditions  | Results<br>Reject/Size |
|---|------------------------|--|------------------------|
| High Temperature Storage Life                 | JESD22-A103            | Ta=125°C, t=1000h  | 0/22                   |
| Low Temperature Storage Life                  | JESD22-A119            | Ta=-55°C, t=1000h  | 0/22                   |
| Temperature Humidity Bias (HAST)              | JESD22-A110            | Ta=130°C, RH=85%, VCC=7V, t=96h  | 0/20                   |
| High Temperature Operating Life               | JESD22-A108            | Ta=85°C, IF=Maximum current within Diode Power Dissipation rating, t=1000h                         | 0/20                   |
| Unbiased Temperature Humidity (Unbiased HAST) | JESD22-A118            | Ta=130°C, RH=85%, t=96h  | 0/22                   |
| Temperature Cycling                           | JESD22-A104            | -40°C~125°C, 850cycles   | 0/22                   |
| Electrostatic discharge (HBM Method)          | JS-001                 | C=100pF, 1.5kΩ, 2000V  | 0/5                    |
| Solderability                                 | J-STD-002              | 245°C, 5s Wet area 95% or more   | 0/22                   |
| Resistance to Soldering Heat                  | JESD22-A113, J-STD-020 | Bake: 125°C, 24h<br>Moisture Soak: 85°C/85%RH, 168h (MSL=1)<br>Reflow: 260°Cmax, 255°Cx30s, 3times | 0/22                   |
| Estimated Failure Rate                        | -                      | Estimated failure rate: 10Fit<br>Ta= 55°C, Ea=0.7eV, C.L.=60%                                      |                        |

MSL Preconditioning was performed prior to Temperature humidity bias, Unbiased Temperature Humidity and Temperature cycling.

Preconditioning Details: 125°C, 24h → 85°C, 85%RH, 168h → Reflow 260°Cmax, 255°Cx30s, 3times

Reliability test results may include data from family representative products.

Criteria shall follow the electrical characteristics in Specifications, except for Solderability.

However, ΔIFHL shall be the initial value ± 50%.